

1 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY
Features

- IEC 61000-4-2 (ESD): Air ± 15 kV, Contact ± 8 kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Ultra-low Profile (0.4mm max) Leadless Surface Mount Package Suitable for Compact Portable Electronics
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

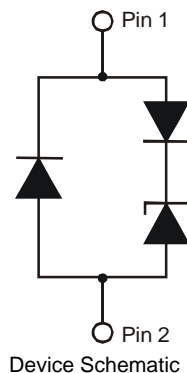
- Case: X2-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 **e4**
- Weight: 0.001 grams (Approximate)

NEW PRODUCT

X2-DFN1006-2



Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
D1213A-01LP4-7B	X2-DFN1006-2	10,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information


U1 = Product Type Marking Code
Line Denotes Pin 1

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I_{PP}	5	A	8/20 μs , Per Figure 2
ESD Protection – Contact Discharge	$V_{ESD_Contact}$	± 8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD_Air}	± 15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	500	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse working voltage	V_{RWM}	—	—	3.3	V	—
Reverse current (Note 6)	I_R	—	0.1	1.0	μA	$V_R = V_{RWM} = 3.3\text{V}$
Reverse breakdown voltage	V_{BR}	6.0	—	—	V	$I_R = 1\text{mA}$
Forward voltage	V_F	0.6	0.8	0.95	V	$I_F = 8\text{mA}$
Reverse clamping voltage, Positive Transients	V_{CL1}	—	10.0	—	V	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$
Reverse clamping voltage, Negative Transients	V_{CL2}	—	-1.7	—	V	$I_{PP} = -1\text{A}, t_p = 8/20\mu\text{s}$
Dynamic resistance	R_{DYN}	—	0.9	—	Ω	$I_R = 1\text{A}, t_p = 8/20\mu\text{s}$
Capacitance	C_T	—	0.85	1.2	pF	$V_R = 1.65\text{V}, f = 1\text{MHz}$

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.

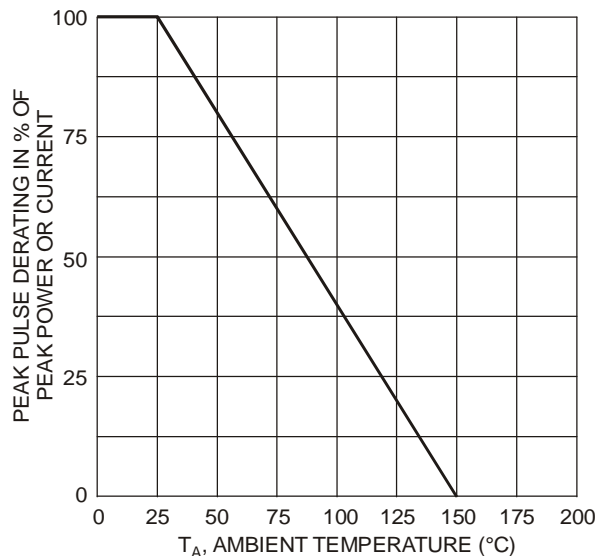


Fig. 1 Pulse Derating Curve

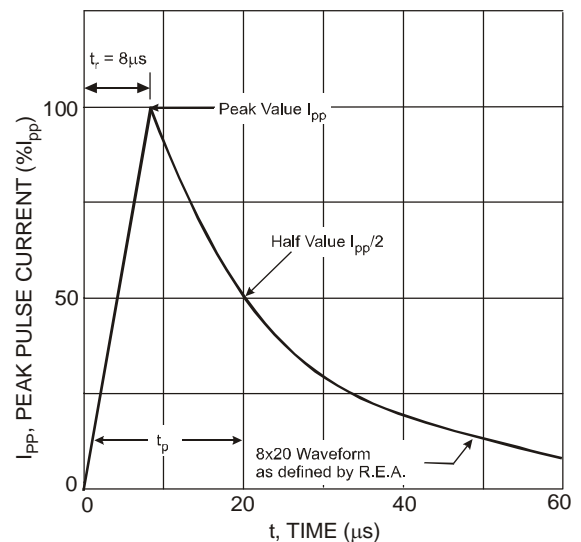
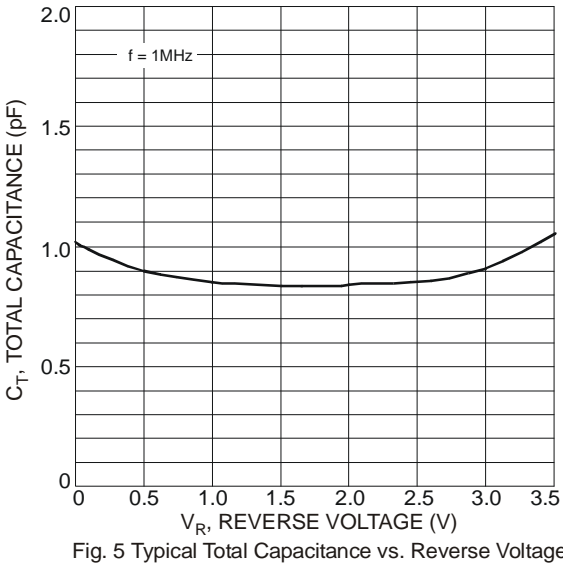
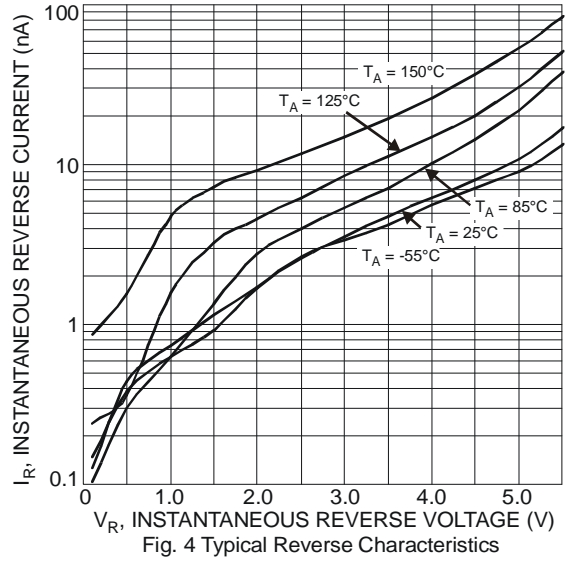
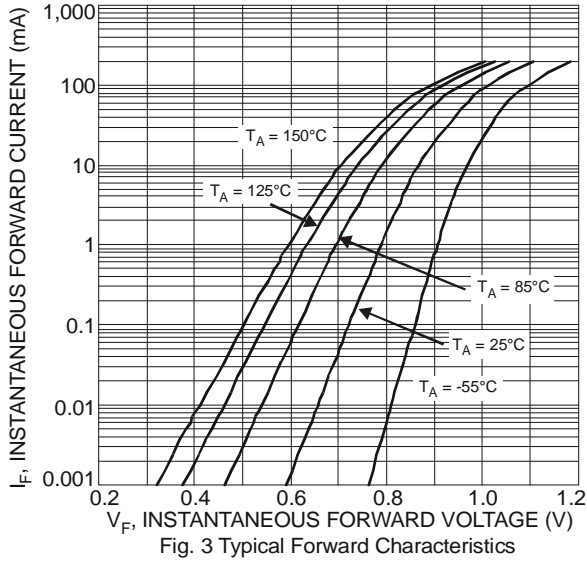
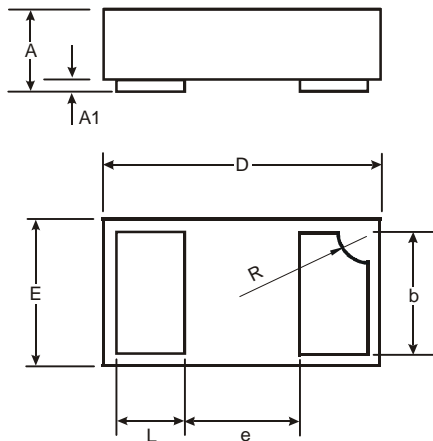


Fig. 2 Pulse Waveform

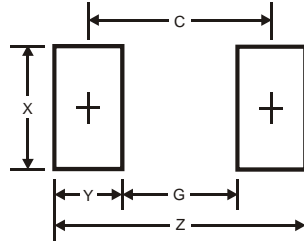


Package Outline Dimensions



X2-DFN1006-2			
Dim	Min	Max	Typ
A	0.34	0.4	0.37
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
E	—	—	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
X	0.7
Y	0.4
C	0.7

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